



DHE0.3A~DHE0.3M

Surface Mount Ultra Fast Rectifiers

Features

- Low profile space
- Ideal for automated placement
- Glass passivated chip junctions
- Low forward voltage drop
- Low leakage current
- High forward surge capability
- High temperature soldering:
260°C/10 seconds at terminals
- Component in accordance to
RoHS 2002/95/1 and WEEE 2002/96/EC



Mechanical Data

- **Case:** JEDEC SOD-123FL molded plastic body over glass passivated chip
- **Terminals:** Solder plated, solderable per J-STD-002B and JESD22-B102D
- **Polarity:** Laser band denotes cathode end
- **Weight:** 0.017gram

Major Ratings and Characteristics

$I_{F(AV)}$	0.3A
V_{RRM}	50 V to 1000 V
I_{FSM}	10A
I_R	5 μ A
V_F	1.0V, 1.3V, 1.7V
$T_j \text{ max.}$	150 °C

Maximum Ratings & Thermal Characteristics

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Items	Symbol	DHE 0.3A	DHE 0.3B	DHE 0.3D	DHE 0.3E	DHE 0.3G	DHE 0.3J	DHE 0.3K	DHE 0.3M	UNIT
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	300	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	35	70	140	210	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	300	400	600	800	1000	V
Maximum average forward rectified current	$I_{F(AV)}$	0.3								A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	10								A
Thermal resistance from junction to ambient ⁽¹⁾	$R_{\theta JA}$	150								°C/W
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +150								°C

Note 1: Mounted on P.C.B. with 0.036 x 0.06" (0.9 x 1.5mm) copper pad areas.

Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Items	Test conditions		Symbol	DHE0.3A~0.3D	DHE0.3E~0.3G	DHE0.3J~0.3M	UNIT
Instantaneous forward voltage	I _F =0.3A ⁽²⁾		V _F	1.0	1.3	1.7	V
Reverse current	V _R =V _{DC}	T _A =25℃	I _R	5			μA
		T _A =100℃		50			
Reverse recovery time	I _F = 0.5 A , I _R = 1.0 A , I _{rr} = 0.25 A		t _{rr}	50		75	nS

Note 2: Pulse test:300 μ s pulse width,1% duty cycle.



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Characteristic Curves ($T_A=25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

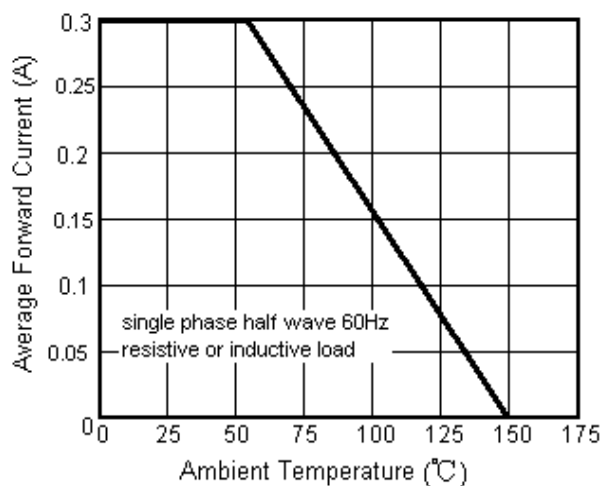


Fig.2 Maximum Non-Repetitive Peak Forward Surge Current

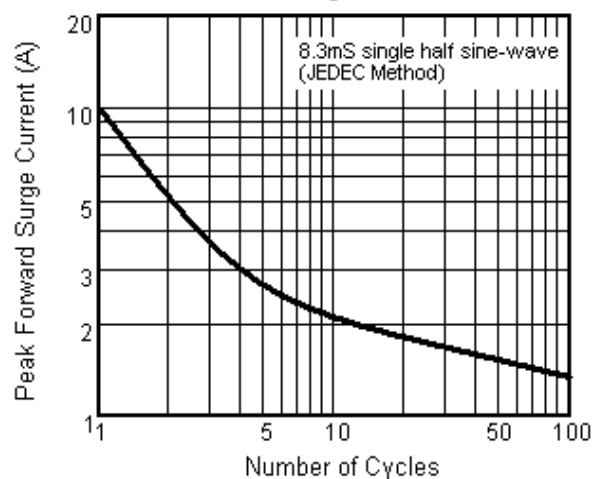


Fig.3 Typical Instantaneous Forward Characteristics

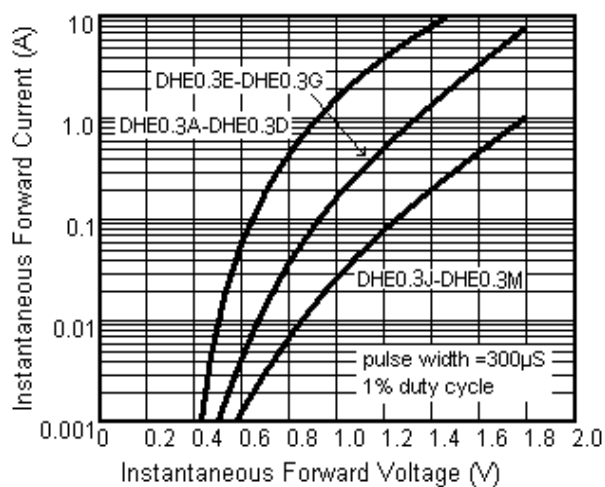
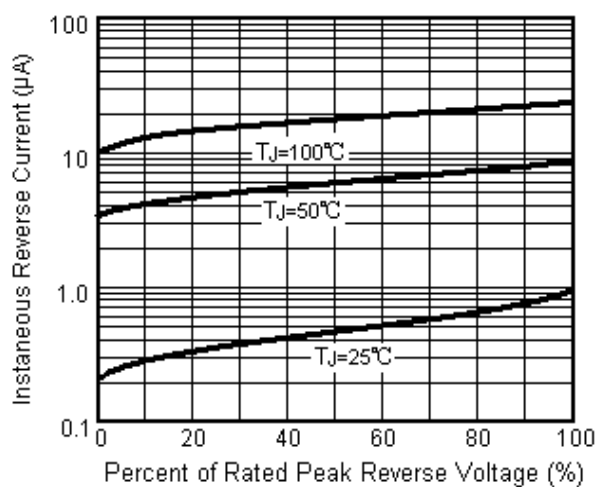


Fig.4 Typical Reverse Characteristics

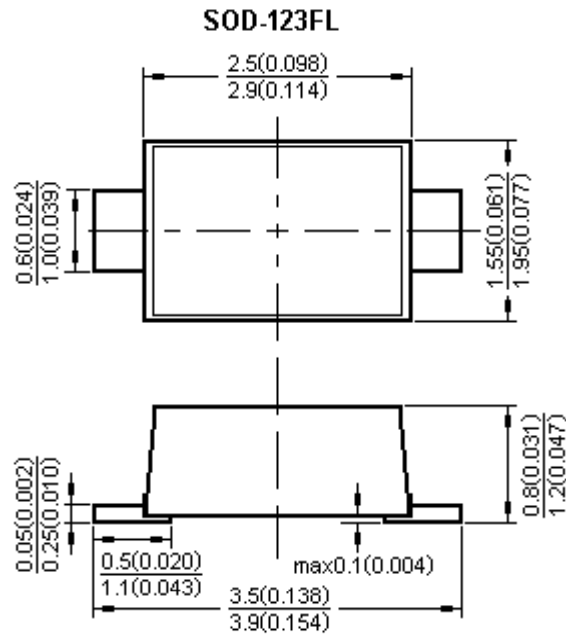




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Surface Mount High Efficiency Recovery rectifiers

Package Outline



Dimensions in millimeters and (inches)

Notice

- Product is intended for use in general electronics applications.
- Product should be worked less than the ratings; if exceeded, may cause permanent damage or introduce latent failure mechanisms.
- The absolute maximum ratings are rated values and must not be exceeded during operation. The following are the general derating methods you design a circuit with a device.
 - $I_{F(AV)}$: We recommend that the worst case current be no greater than 80% .
 - I_{FSM} : This rating specifies the non-repetitive peak current. This is only applied for an abnormal operation, which the general during the lifespan of the device.
 - T_J : Derate this rating when using a device in order to ensure high reliability. We recommend that the device be used at a T_J of below 125°C.

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